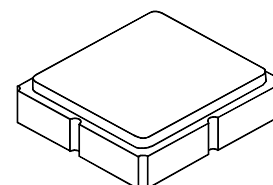




- RF Filter for GPS Receiver
- Surface Mount 3.0 x 3.0 mm Package
- Complies with Directive 2002/95/EC (RoHS)

**SF2193E****1228 MHz  
SAW Filter****SM3030-8****Absolute Maximum Ratings**

Rating	Value	Units
Input Power Level	5	dBm
DC Voltage on any Non-ground Terminal	3	V
Operating Temperature Range	-30 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Maximum Soldering Profile, 5 cycles/10 seconds maximum	265	°C

**Electrical Characteristics**

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	F <sub>C</sub>			1228		MHz
Insertion Loss, 1218 to 1238 MHz	IL			3.4	4.4	dB
Amplitude Ripple, 1218 to 1238 MHz				0.9	1.7	dB
Attenuation, 0 dB Reference:						dB
0 to 1088 MHz			40	52		
1088 to 1178 MHz			32	50		
1178 to 1190 MHz			15	50		
1268 to 1288 MHz			13	29		
1288 to 1378 MHz			30	41		
1378 to 1480 MHz			36	54		
1480 to 2500 MHz			28	47		
2500 to 4000 MHz			13	20		
Source Impedance, Unbalanced	Z <sub>S</sub>			50		Ω
Load Impedance, Balanced	Z <sub>L</sub>			50		
Case Style	SM3030-8 3.0 x 3.0 mm Nominal Footprint					
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	906, YWWS					
Standard Reel Quantity	Reel Size 7 Inch	500 Pieces/Reel				
	Reel Size 13 Inch	3000 Pieces/Reel				

**Electrical Connections**

	Connection	Terminals
	Unbalanced Input	2
	Balanced Output	5, 7
	Ground	All Others

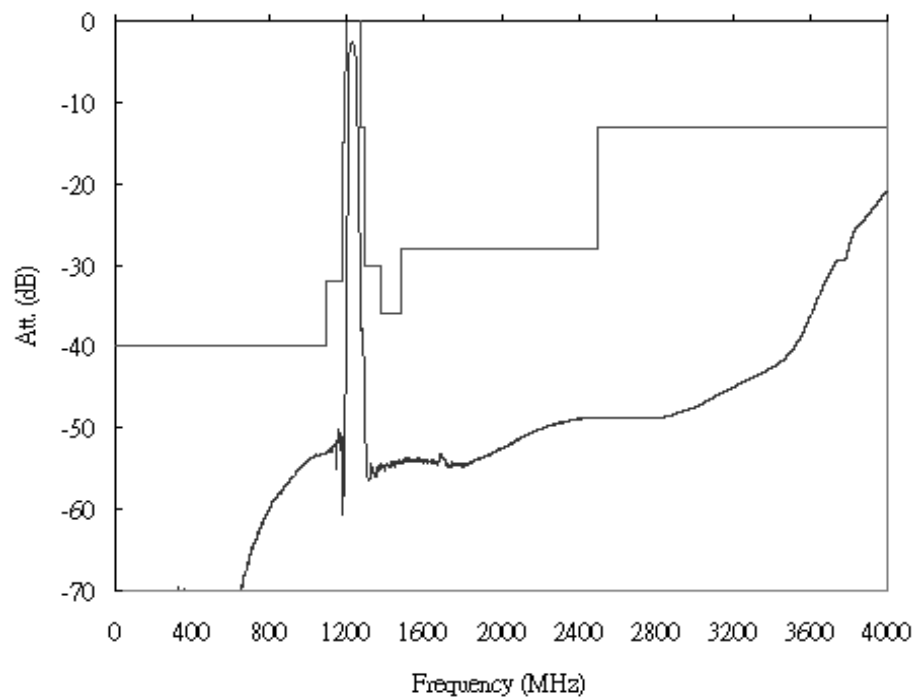
Dot Indicates Pin 1

**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.****Notes:**

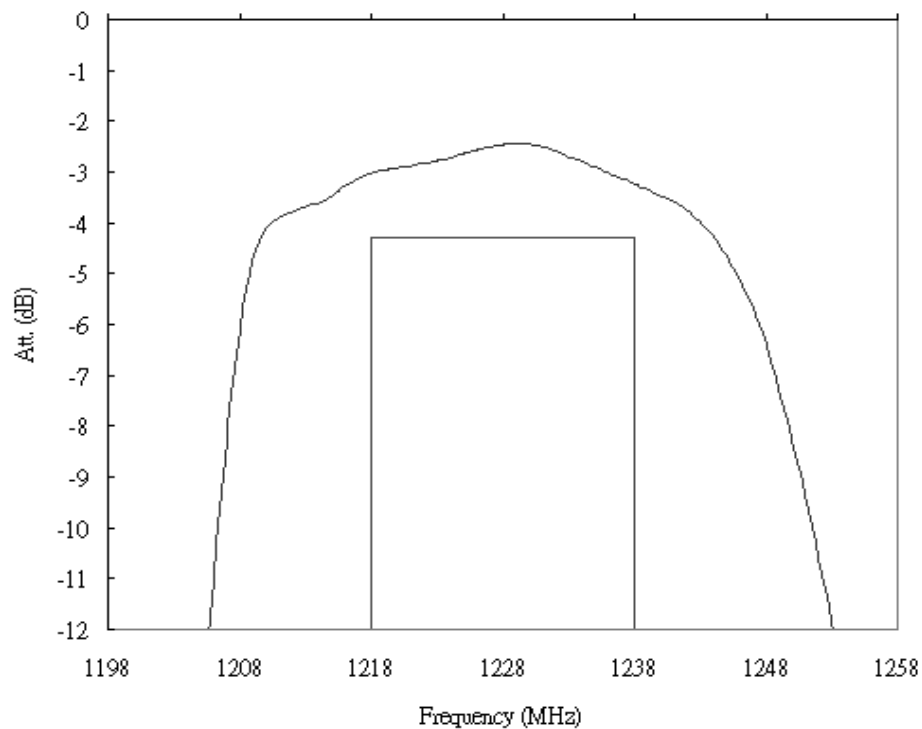
1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, f<sub>c</sub>.
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
7. US and international patents may apply.
8. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.

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## Filter Wideband Response

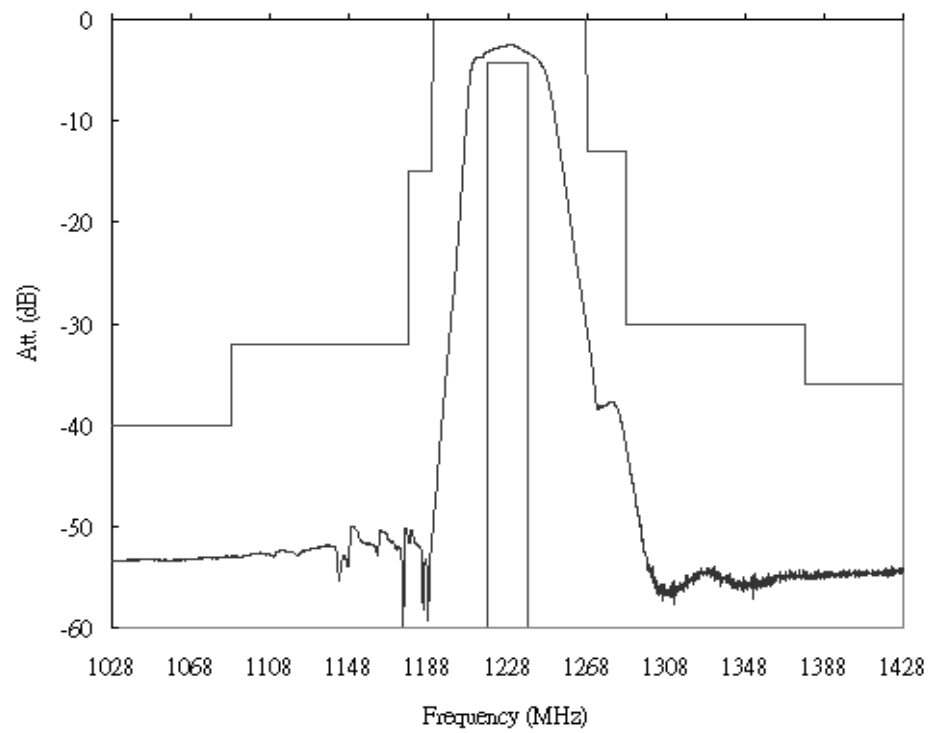


## Filter Passband Response

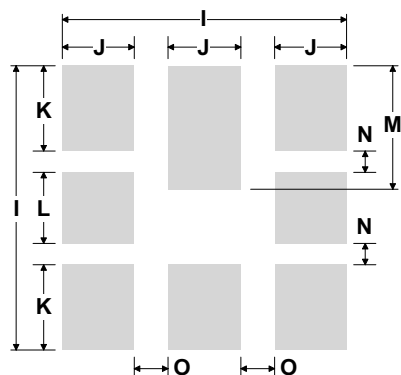
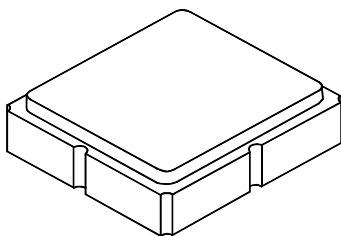


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## Filter Near-in Response



## 8-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint



PCB Footprint Top View

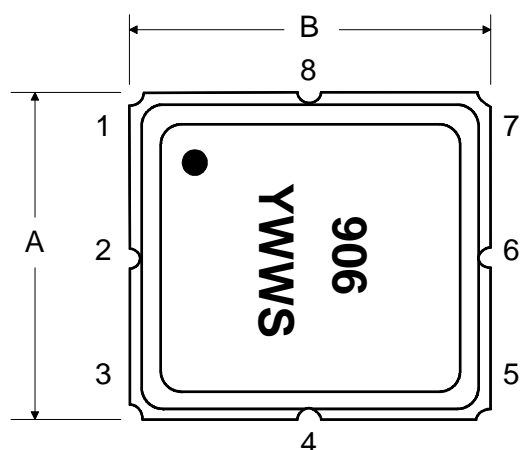
Case and PCB Footprint Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.0	3.13	0.113	0.118	0.123
B	2.87	3.0	3.13	0.113	0.118	0.123
C	1.14	1.27	1.40	0.045	0.050	0.055
D	0.79	0.92	1.05	0.031	0.036	0.041
E	0.62	0.75	0.88	0.024	0.029	0.034
F	0.47	0.60	0.73	0.018	0.024	0.029
G	0.47	0.60	0.73	0.018	0.024	0.029
H	1.07	1.20	1.33	0.042	0.047	0.052
I		3.19			0.126	
J		0.81			0.032	
K		0.96			0.038	
L		0.81			0.032	
M		1.39			0.055	
N		0.23			0.009	
O		0.38			0.015	

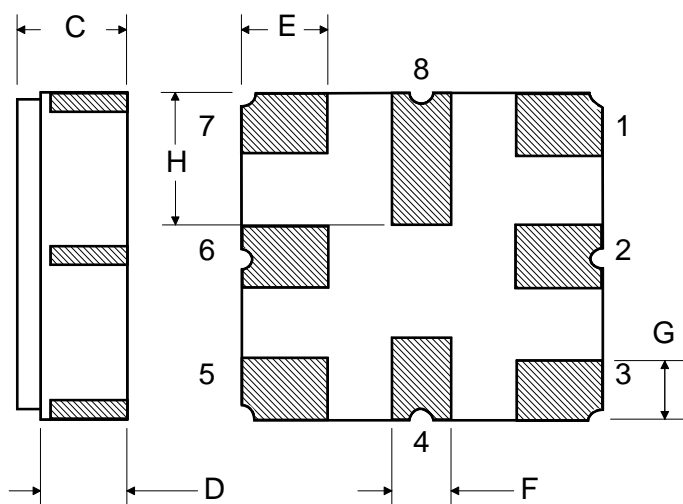
Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 $\mu$ m Gold over 1.27 to 8.89 $\mu$ m Nickel
Lid Plating	2.0 to 3.0 $\mu$ m Nickel
Body	$Al_2O_3$ Ceramic
Pb Free	

TOP VIEW



BOTTOM VIEW



Technical drawing of a circular component, likely a flange or end plate, showing three views: a top view, a side view, and a detail view.

**Top View:** A large circle with a smaller concentric circle in the center. A crosshair (dashed lines) indicates the center. A leader line points from the text "See Detail 'A'" to the center of the inner circle.

**Side View:** A vertical cross-section showing the thickness of the component. The total thickness is dimensioned as 12.0. The inner hole is dimensioned as 100 REF. (Reference). The outer diameter is dimensioned as "B" REF. (Reference).

**Detail View (Detail A):** A cross-section of the central hole. It shows a circular hole with a diameter of 13.0. The hole is surrounded by a flange with a thickness of 2.0. The outer diameter of the flange is dimensioned as 20.2.

Carrier Tape Dimensions	
Ao	3.35 mm
Bo	3.35 mm
Ko	1.4 mm
Pitch	8.0 mm
W	12.0 mm

0.3 ± 0.05

RO.3 (MAX.)

PIN #1

2.0

4.0

Ø1.50

A

1.75

5.5

12.0

Bo

B

Pitch

Ao

Ø1.5

R0.5 (MAX.)

SECTION A-A

SECTION B-B

USER DIRECTION OF FEED